Abstract

An insulating-film forming material comprising a resin (A) that has a structure represented by formula (I):

$$-+0-Y_1-0-Ar_1++0-Y_2-0-Ar_2+m$$

(I)

wherein Y_1 , Y_2 , Ar_1 and Ar_2 are the same or different; each of Y_1 , Y_2 , Ar_1 and Ar_2 represents an aromatic ring-containing divalent organic group; at least one of Y_1 and Y_2 is a divalent aromatic polycyclic group having a specific structure; m and n each indicates a molar percentage of the repeating units; and m falls between 0 and 100 with (m + n) = 100.